

	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△						△					
△						△					
APPLICABLE STANDARD											
RATING	Operating Temperature Range		-55℃ to 105℃ (Note1)			Storage Temperature Range		-10℃ to +60℃ (Note3)			
	Operating Humidity Range		20% to 80% (Note2)			Storage Humidity Range		40% to 70% (Note3)			
	Applicable Connector		DF51K-10DS-2C(###)			Current	AWG 30 : 0.5A AWG 28 : 1A AWG 26 : 1.5A AWG 22-24 : 2A				
	Voltage		250V AC/DC								
SPECIFICATIONS											
ITEM		TEST METHOD				REQUIREMENTS			QT	AT	
CONSTRUCTION											
General Examination		Visually and by measuring instrument.				According to drawing.			O	O	
Marking		Confirmed visually.							O	O	
ELECTRICAL CHARACTERISTICS											
Contact Resistance		20mV MAX, 1mA (DC or 1000Hz).				30 mΩ MAX.			O	-	
Millivolt Level Method											
Insulation Resistance		500 V DC.				1,000 MΩ MIN.			O	-	
Voltage Proof		650 V AC for 1 min.				No flashover or breakdown.			O	-	
MECHANICAL CHARACTERISTICS											
Mechanical Operation (Sn Plating)		30 times insertion and extraction.				①Contact resistance: 30mΩ MAX ②No damage, crack or looseness of parts.			O	-	
Mechanical Operation (Au Plating)		50 times insertion and extraction.				①Contact resistance: 30mΩ MAX ②No damage, crack or looseness of parts.			O	-	
Mating and unmating force (Sn Plating)		It takes out and inserts with a conformity connector.				①Insertion Force: 48.2N MAX ②Extraction Force: 2.7N MIN			O	-	
Mating and unmating force (Au Plating)		It takes out and inserts with a conformity connector.				①Insertion Force: 31.2N MAX ②Extraction Force: 2.5N MIN			O	-	
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 10 cycles for 3 direction.				①No electrical discontinuity of 1 μ s. ②No damage, crack or looseness of parts.			O	-	
Shock		Acceleration 490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.							O	-	
ENVIRONMENTAL CHARACTERISTICS											
Damp Heat (Steady State)		Exposed at 40 ± 2 ℃ , humidity 90 to 95 %, 96 h. (After leaving the room temperature for 1 to 2h.)				①Contact resistance: 30 mΩ MAX. ②Insulation resistance: 500MΩ MIN. ③No damage, crack or looseness of parts.			O	-	
Remarks Note 1: Include the temperature rising by current. Note 2: No condensing Note 3: Apply to the condition of long term storage for unused products before pcb on board, after pcb board , operating temperature and humidity range is applied for interim storage during transportation.											
					DRAWN J.S CHOI 18.03.02	DESIGNED J.S CHOI 18.03.02	CHECKED S.M.LIM 18.03.02	APPROVED T.S KANG 18.03.02	RELEASED <div>ENG 20.02.13 DEPT</div>		
Unless otherwise specified, refer to IEC 60512.											
NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST											
HIROSE KOREA CO.,LTD.			SPECIFICATION SHEET				PART NO. DF51K-10DP-2DS(805)				
CODE NO.(OLD) CL		DRAWING NO. ELC4-632479			CODE NO. CL 6652-0055-0-805					1/2	

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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

Rapid Change of Temperature	Temperature -55 °C → +105 °C Time 30min → 30min Under 5 Cycles. (The transferring time of the tank is 2 to 3 MIN) (After leaving the room temperature for 1 to 2h.)	①Contact resistance: 30 mΩ MAX. ②Insulation resistance: 1,000MΩ MIN. ③No damage, crack or looseness of parts.	O	—
Dry Heat	Exposed at 105±2 °C, 96h	①Contact resistance: 30 mΩ MAX. ②Insulation resistance: 1,000MΩ MIN. ③No damage, crack or looseness of parts.	O	—
Cold	Exposed at -55±3 °C, 96h	①Contact resistance: 30 mΩ MAX. ②Insulation resistance: 1,000MΩ MIN. ③No damage, crack or looseness of parts.	O	—
Resistance To Soldering Heat	①Automatic soldering (flow) Soldered at solder temperature, 260 °C for in immersion , duration, 5 s. ②Manual soldering Soldering iron temperature :270 °C, Soldering time :3s. No strength on contact.	No deformation of case of excessive looseness of the terminals.	O	—
Solderability	Soldering temperature: 245 °C Duration of immersion :soldering, for 5 sec.	New uniform coating of solder shall cover minimum of 95 % of the surface Being immersed.	O	—

NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST O: APPLICABLE TEST				
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